

# Germanium Power Devices Corp.

## SILICON UNIJUNCTION TRANSISTOR

## Specifications

Silicon Unijunction Transistors are three-terminal devices having a stable "N" type negative resistance characteristic over a wide temperature range. A stable peak point and a high peak current rating make these devices useful in oscillators, timing circuits, trigger circuits, and bistable circuits, where it can serve the purpose of two conventional silicon transistors.

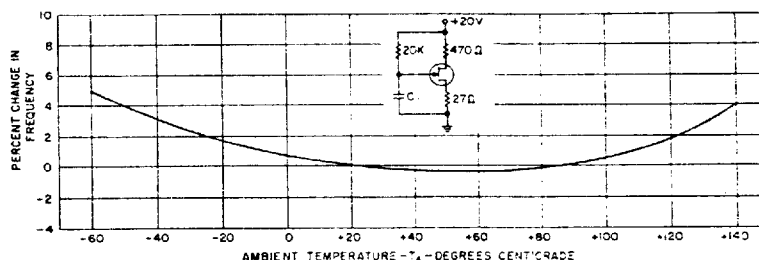
Fixed-Bed Construction makes these transistors extremely reliable under severe conditions of mechanical shock, vibration, centrifugal force, and thermal shock. It also provides a lower terminal resistance and improved uniformity of electrical characteristics. These transistors are hermetically sealed in welded cases. Types 2N489 through 2N494 are housed in TO-5 size cases with special lead configuration (TO-33)

SILICON TYPES

2N489, A, B

THROUGH

2N494, A, B



### absolute maximum ratings\*

Total RMS Power Dissipation—Unstabilized<sup>3</sup>  
Total RMS Power Dissipation—Stabilized<sup>3</sup>  
RMS Emitter Current  
Peak Emitter Current<sup>4</sup> ( $T_J = 150^\circ\text{C}$ )  
Emitter Reverse Voltage ( $T_J = 150^\circ\text{C}$ )  
Operating Temperature Range  
Operating Temperature Range—Stabilized<sup>3</sup>  
Storage Temperature Range

2N489, A, B  
THROUGH  
2N494, A, B

450<sup>1</sup>  
600<sup>1</sup>

70  
2  
60  
-65 to +140  
-65 to +175  
-65 to +175

mw  
mw  
ma  
amps  
volts  
 $^\circ\text{C}$   
 $^\circ\text{C}$   
 $^\circ\text{C}$

### FEATURES

- Stable Operation over Wide Temperature Range
- Low Leakage Current
- Low Peak Point Current
- Guaranteed Minimum Pulse Voltage

1. Derate 3.9 mw/ $^\circ\text{C}$  increase in amb. temp. (Thermal resistance to case =  $0.16^\circ\text{C}/\text{mw}$ )
2. Derate 2.6 mw/ $^\circ\text{C}$  increase in amb. temp. (Thermal resistance to case =  $0.08^\circ\text{C}/\text{mw}$ )
3. Under normal operation, thermal runaway conditions cannot exist with the UJT up to a junction temperature of  $140^\circ\text{C}$  since the temperature coefficient of  $R_{BB}$  is positive below this temperature and  $I_{E0}$  is negligible. For this reason an unstabilized power rating can be used with the UJT which is derated to zero at  $140^\circ\text{C}$ . The UJT can be used at temperatures above  $140^\circ\text{C}$  but in this case external resistance must be used in the emitter and interbase circuits to limit the power dissipation and prevent thermal runaway. The power rating for this condition is the stabilized power rating and is derated to zero at  $175^\circ\text{C}$ . It is also important to provide circuit stabilization in the interbase circuit when the UJT is used in pulse type applications since the instantaneous temperature of the silicon could rise to a high enough value to permit runaway.
4. Emitter peak current should be limited to two amperes for discharge capacitances up to  $10\mu\text{fd}$ , with a peak point voltage of 30 volts. For higher values of C or  $V_{PP}$ , resistance must be added in series with the capacitor to protect the emitter circuit.

### Description

General Electric's Silicon Unijunction Transistor consists of an "N" type silicon bar mounted between two ohmic base contacts with a "P" type emitter near base-two. The device operates by conductivity modulation of the silicon between the emitter and base-one when the emitter is forward biased. In the cutoff, or standby condition, the emitter and interbase power supplies establish potentials between the base contacts, and at the emitter, such that the emitter is back biased. If the emitter potential is increased sufficiently to overcome this bias, holes (minority carriers) are injected into the silicon bar. These holes are swept toward base-one by the internal field in the bar. The increased charge concentration, due to these holes, decreases the resistance and hence decreases the internal voltage drop from the emitter to base-one. The emitter current then increases regeneratively until it is limited by the emitter power supply. The effect of this conductivity modulation is also noticed as an effective modulation of the interbase current.

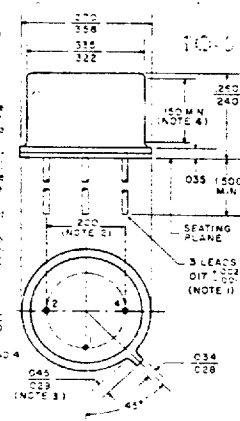
\* $25^\circ\text{C}$ , unless otherwise specified.

DIMENSIONS WITHIN  
JEDEC OUTLINE TO-5  
EXCEPT FOR LEAD  
CONFIGURATION

NOTE 1: LEAD CENTER TO CENTER DISTANCE BETWEEN 330 AND 340 OF 330 ± 0.10  
NOTE 2: LEAD CENTER TO CENTER DISTANCE BETWEEN 330 AND 340 OF 330 ± 0.10  
NOTE 3: MAXIMUM FROM MAX. DIAMETER OF THE BASE CONTACT  
NOTE 4: THIS DIMENSION IS FOR THE LEAD CENTER TO CENTER DISTANCE BETWEEN 330 AND 340 OF 330 ± 0.10

ALL DIMENSIONS IN INCHES AND ARE  
REFERENCE UNLESS TOLERANCES

EMITTER 1  
BASE ONE 2  
BASE TWO 3



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Unijunction Transistors are specified primarily in three ranges of stand-off ratio and two ranges of interbase resistance. Each range of stand-off ratio has limits

of  $\pm 10\%$  from the center value and each range of interbase resistance has limits of  $\pm 20\%$  from the center value.

Type No.	Intrinsic Standoff Ratio  (See note 1) $V_{BB} = 10V$  $\eta$  Min. Max.	Interbase Resistance  (See note 2) $V_{BB} = 3V$  $R_{BB}$ ohms  Min. Max.	Modulated Interbase Current  $I_E = 50 \text{ ma}$ $V_{BB} = 10V$  $I_{B(MOD)}$ ma  Min. Max.	MAXIMUM					MINIMUM		
				Emitter Saturation Voltage  $I_E = 50 \text{ ma}$ $V_{BB} = 10V$  $V_{E(SAT)}$ volts	Emitter Reverse Current			Peak Point Current  $V_{BB} = 25V$  $I_P$ $\mu\text{a}$	Valley Point Current  $R_{BB} = 100\Omega$ $V_{BB} = 20V$  $I_V$ ma	Base One Peak Pulse Voltage  (See note 3)  $V_{OB1}$ volts	
					$V_{RBE} = 60V$  $I_{EB20} \mu\text{a}$	$T_J = 150^\circ\text{C}$ $V_{RBE} = 10V$  $I_{EB20} \mu\text{a}$	$V_{RBE} = 30V$  $I_{EB20} \mu\text{a}$				
2N489	.51 .62	4.7 6.8	6.8 22	5	2	20		12	8		
2N489A	.51 .62	4.7 6.8	6.8 22	4	2	20		12	8	3	
2N489B	.51 .62	4.7 6.8	6.8 22	4	2	20	0.2	6	8	3	
2N490	.51 .62	6.2 9.1	6.8 22	5	2	20		12	8		
2N490A	.51 .62	6.2 9.1	6.8 22	4	2	20		12	8	3	
2N490B	.51 .62	6.2 9.1	6.8 22	4	2	20	0.2	6	8	3	
2N491	.56 .68	4.7 6.8	6.8 22	5	2	20		12	8		
2N491A	.56 .68	4.7 6.8	6.8 22	4.3	2	20		12	8	3	
2N491B	.56 .68	4.7 6.8	6.8 22	4.3	2	20	0.2	6	8	3	
2N492	.56 .68	6.2 9.1	6.8 22	5	2	20		12	8		
2N492A	.56 .68	6.2 9.1	6.8 22	4.3	2	20		12	8	3	
2N492B	.56 .68	6.2 9.1	6.8 22	4.3	2	20	0.2	6	8	3	
2N493	.62 .75	4.7 6.8	6.8 22	5	2	20		12	8		
2N493A	.62 .75	4.7 6.8	6.8 22	4.6	2	20		12	8	3	
2N493B	.62 .75	4.7 6.8	6.8 22	4.6	2	20	0.2	6	8	3	
2N494	.62 .75	6.2 9.1	6.8 22	5	2	20		12	8		
2N494A	.62 .75	6.2 9.1	6.8 22	4.6	2	20		12	8	3	
2N494B	.62 .75	6.2 9.1	6.8 22	4.6	2	20	0.2	6	8	3	

1. The intrinsic standoff ratio,  $\eta$ , is essentially constant with temperature and interbase voltage.  $\eta$  is defined by the equation:

$$V_P = \eta V_{BB} + \frac{200}{T_J}$$

Where

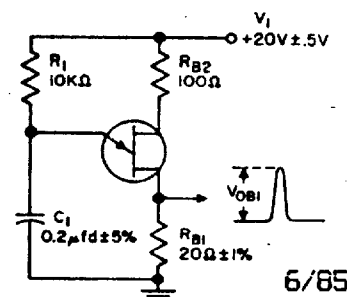
$V_P$  = Peak point emitter voltage

$V_{BB}$  = Interbase voltage

$T_J$  = Junction Temperature (Degrees Kelvin)

2. The interbase resistance is nearly ohmic and increases with temperature in a well defined manner. The temperature coefficient at  $25^\circ\text{C}$  is approximately  $0.8\%/^\circ\text{C}$ .

3. The base-one peak pulse voltage is measured in the circuit at right. This specification on the A and B versions is used to ensure a minimum pulse amplitude for applications in SCR firing circuits and other types of pulse circuits.



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